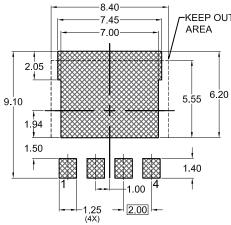


RECOMMENDED LAND PATTERN

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



UNIVERSAL LAND PATTERN*

DIM	MILLIMETERS				
DIW	MIN.	NOM.	MAX.		
Α	0.82	0.92	1.02		
A1	0.00	_	0.05		
b	0.90	1.00	1.10		
b1	0.35	0.45	0.55		
С	0.23	0.28	0.33		
D	8.20	8.30	8.40		
D1	8.00 BSC				
D2	6.80	6.90	7.00		
D3	6.90	7.00	7.10		
D4	5.52	5.67	5.82		
D5	1.16 REF				
E	8.30	8.40	8.50		
E1	7.90 BSC				
E2	5.24	5.34	5.44		
E3	0.25	0.35	0.45		
E4	6.08	6.23	6.38		
E5	1.13 REF				
е	2.00 BSC				
e/2	1.00 BSC				
e1	2.70 BSC				
e1/2	1.35 BSC				
K	1.50	1.57	1.70		
L	0.64	0.74	0.84		
L1	0.67	0.77	0.87		
θ	0°	_	12°		

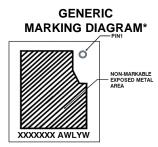
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DESCRIPTION:	TDFNW8 8.30x8.40x0.92, 2.00P		PAGE 1 OF 2	

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CASE 507AS ISSUE C

DATE 28 MAY 2024



XXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot Code
Y = Year Code
W = Work Week Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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